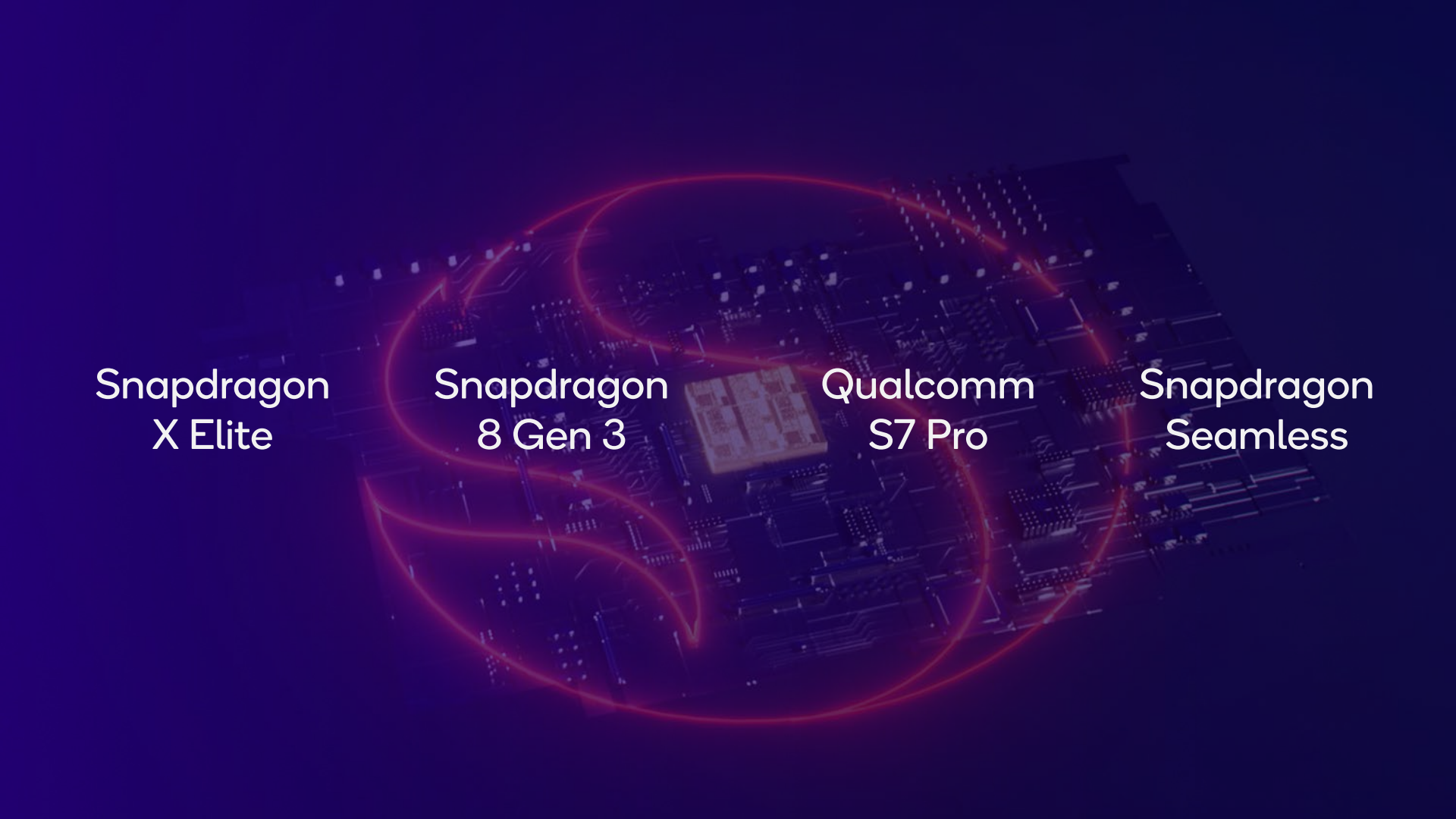


Qualcomm

KEDAR KONDAP

SVP and GM, Compute and Gaming
Qualcomm Technologies, Inc.



Snapdragon
X Elite

Snapdragon
8 Gen 3

Qualcomm
S7 Pro

Snapdragon
Seamless



Intuitive cross-device experiences

Qualcomm

HONOR

Qualcomm

GEORGE ZHAO

Chief Executive Officer
HONOR Device Co., Ltd.

HONOR

A large fleet of sailboats is racing on a choppy sea under a dark, overcast sky. The boats are spread across the horizon, with their sails catching the wind. The water is dark and turbulent, with whitecaps visible. The sky is a deep, dark blue-grey, suggesting a storm or late evening. The overall mood is dramatic and intense.

Creating a New Intelligent World Through Open Collaboration

Openness

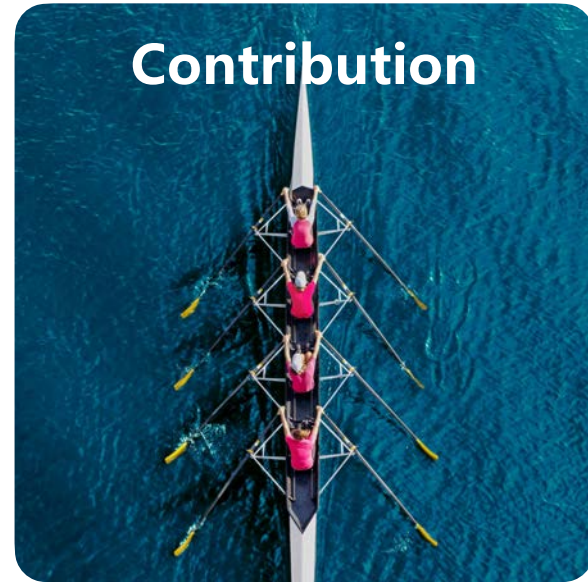


Our Vision

Collaboration



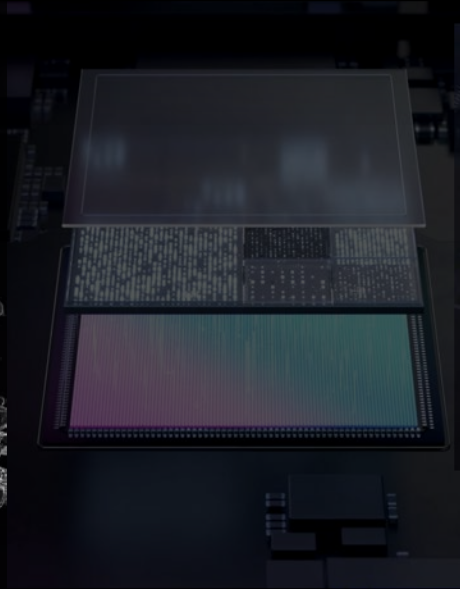
Contribution



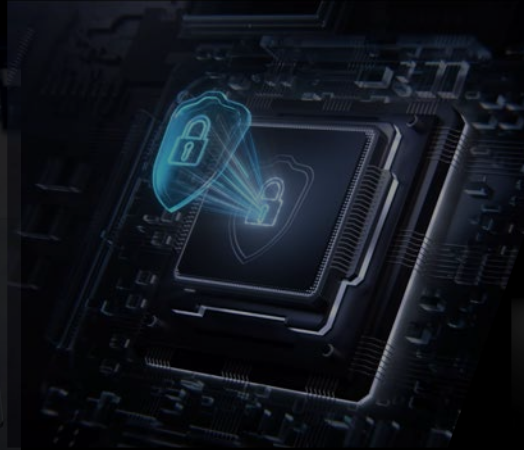
In-depth Collaboration Between Qualcomm Technologies and HONOR



Smartphones



Platform Level AI



Dual-TEE &
Discrete Security Chipset



PCs

Breaking the Boundaries Between Foldables and Bar Phones

HONOR Magic V2

9.9mm



HONOR V Purse

8.6mm

Parallel Spaces Maximize Smartphone Utility



Synergy Between Magic V2 and Snapdragon

Parallel Spaces Maximize Smartphone Utility



Synergy Between Magic V2 and Snapdragon

Collaborating to Create an AI-enabled Cross-platform Ecosystem



Harnessing On-device LLM to Power Platform Level AI

Personal

Intuitive

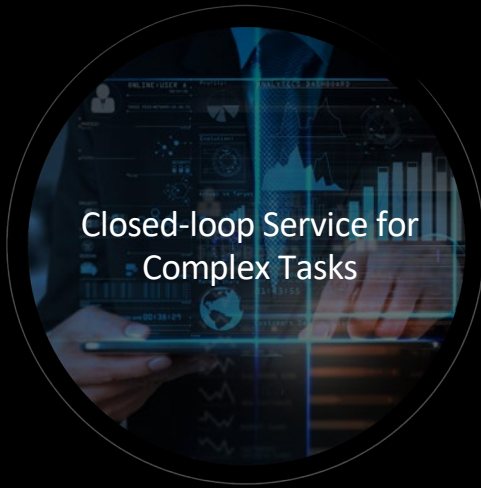
Privacy Protection



Multimodal Natural
Interaction



Intent Recognition



Closed-loop Service for
Complex Tasks

Hybrid LLM Provides the Best of Both Worlds



2-10B+

10-100B+



On-device Personal Knowledge Base

Data Training

Massive Data Capacity on Cloud

User-centric Scenarios

AI Model

General Scenarios

On-device, Balancing Power Consumption

Resources

Cloud Storage Flexibility

Data Stays on Your Device

Privacy & Security

Data is Sent to Cloud

Overcome On-device LLM Development Challenges with Qualcomm Technologies



High Performance

Optimized inference capability of LLMs harnessing Qualcomm® Hexagon NPU



Low Power Consumption

Optimized device NPU scheduling, ensuring smooth and power-efficient processing of LLM applications

On-device LLM

HONOR



Snapdragon



Privacy

Optimized data channel protection for LLM to ensure data stays on device for enhanced privacy

A Sneak Peak of On-device AI

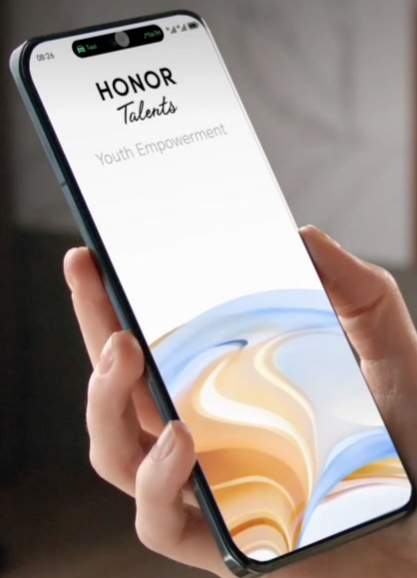


HONOR Magic6

Powered by On-device LLM
with 7 Billion Parameters



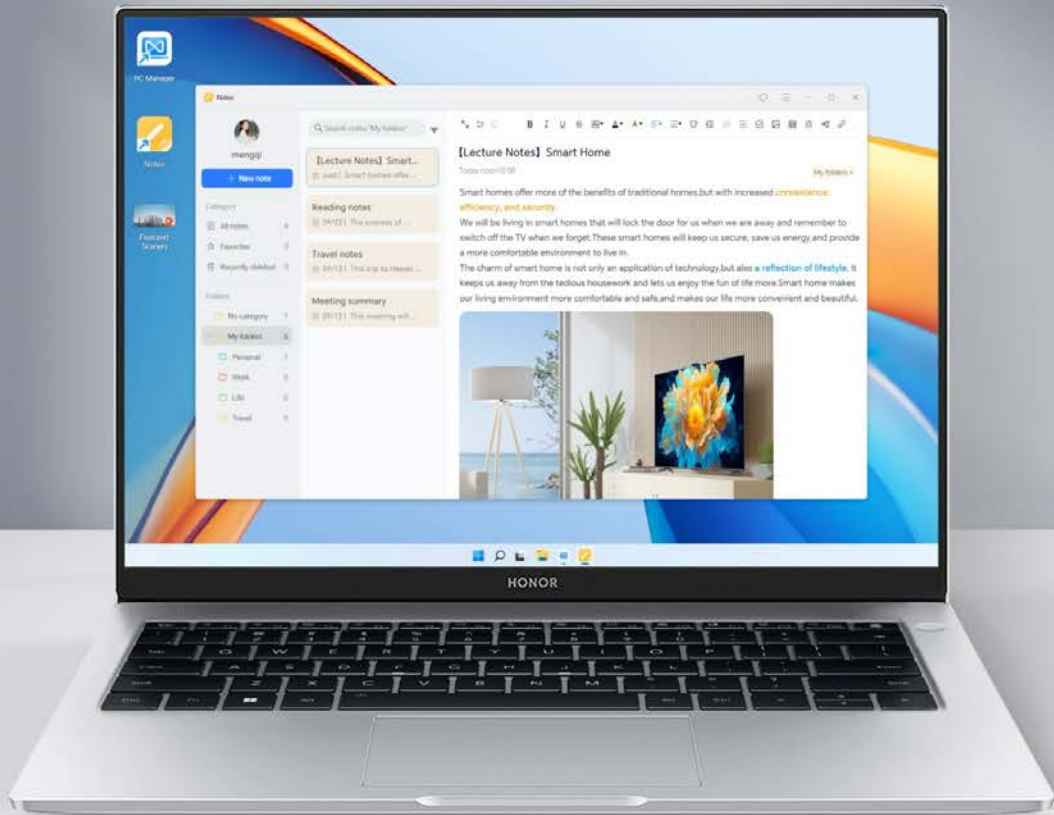
Magic Capsule, Eye Tracking-based Multimodal Interaction



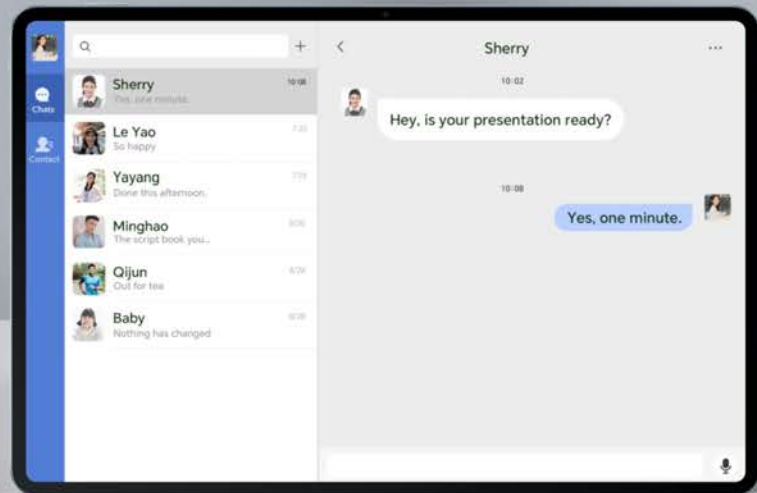
MagicRing Facilitates Seamless Data Exchange Between Devices



Auto attached in the note



One Set of Mouse and Keyboard Multiple Devices Controlled



HONOR PC Powered by Snapdragon X Elite

Mid-2024



Incredible Performance



Lightweight & Slim



On-device AI



Multi-device Connectivity

The background is a deep blue gradient. At the top, several bright blue light rays emanate from a point just above the center, spreading outwards. In the lower half, there are horizontal, wavy lines of a lighter blue color, resembling a digital or liquid surface. A bright, glowing point of light is positioned at the center of these waves, creating a lens flare effect. The overall composition is symmetrical and futuristic.

Collaborate with the Wider Industry with Human-centric
Innovation for an Intelligent Future

Qualcomm

MANJU VARMA

Director, Product Management
Qualcomm Technologies, Inc.

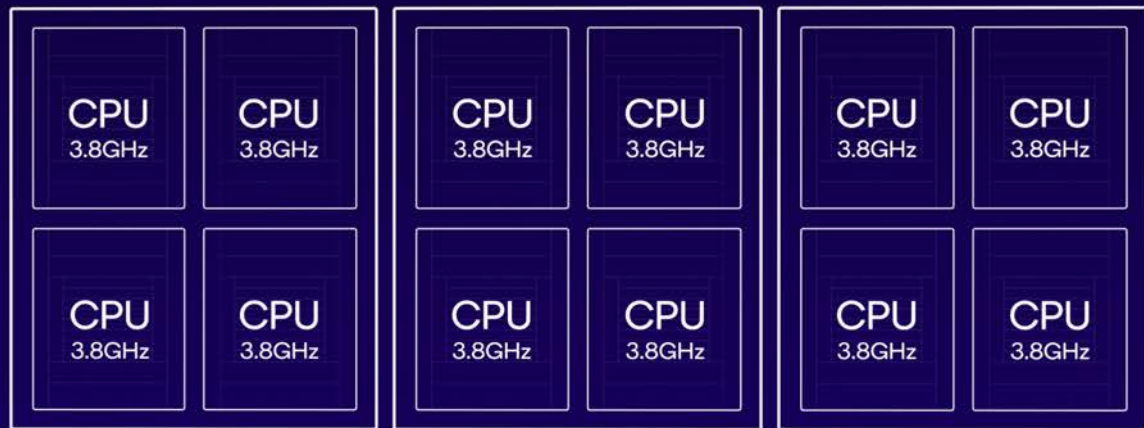




4nm
processor

12
high-performance
cores

3.8GHz



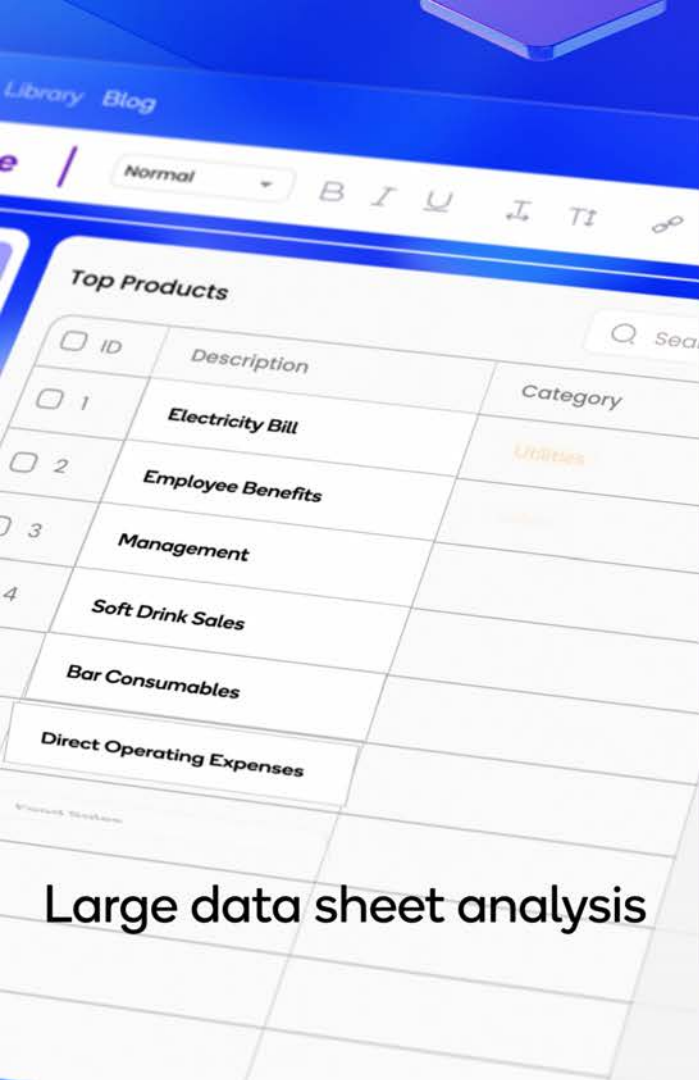


Dual-core boost up to

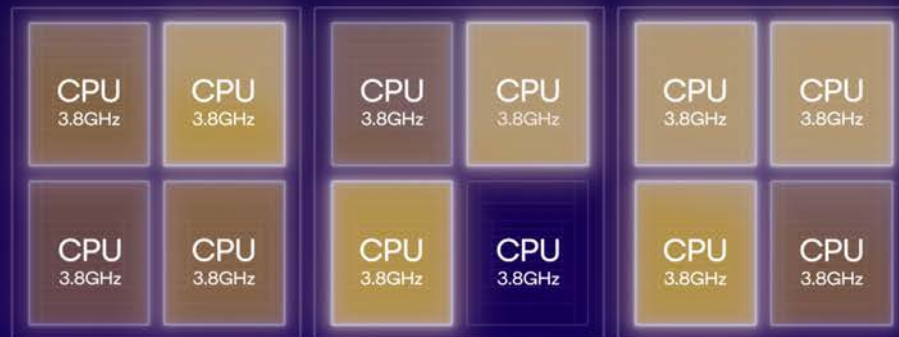
4.3GHz







Large data sheet analysis



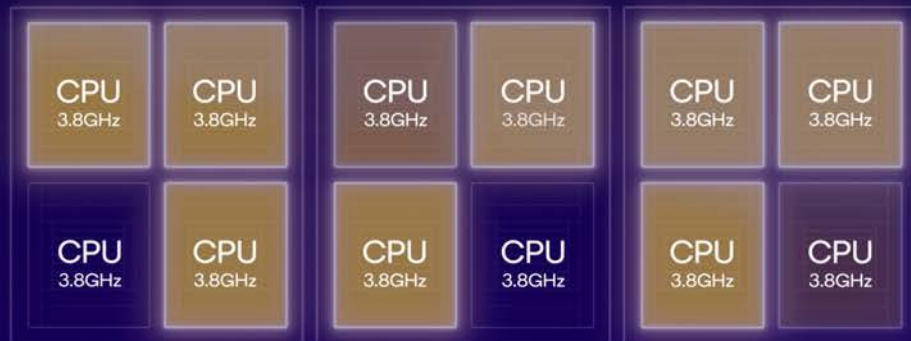
```
    throw er; // Unhandled 'error' event
Emitted 'error' event on Server instance at:
    at emitErrorNT (node:net:1767:8)
    at process processTicksAndRejections(
code: EADDRINUSE',
errno: -4091,
syscall: 'listen',
address',
port: 5000
} Node.js v18.16.0
```

```
C:\Users\kgarett\builds\ContosoChat> Get-Process -l
Stop-Process
```

```
C:\Users\kgarett\builds\ContosoChat> npm run build
```

```
[ ] / idealTree: boilerp
```

Code compilation





State-of-the-art CPU
memory architecture design

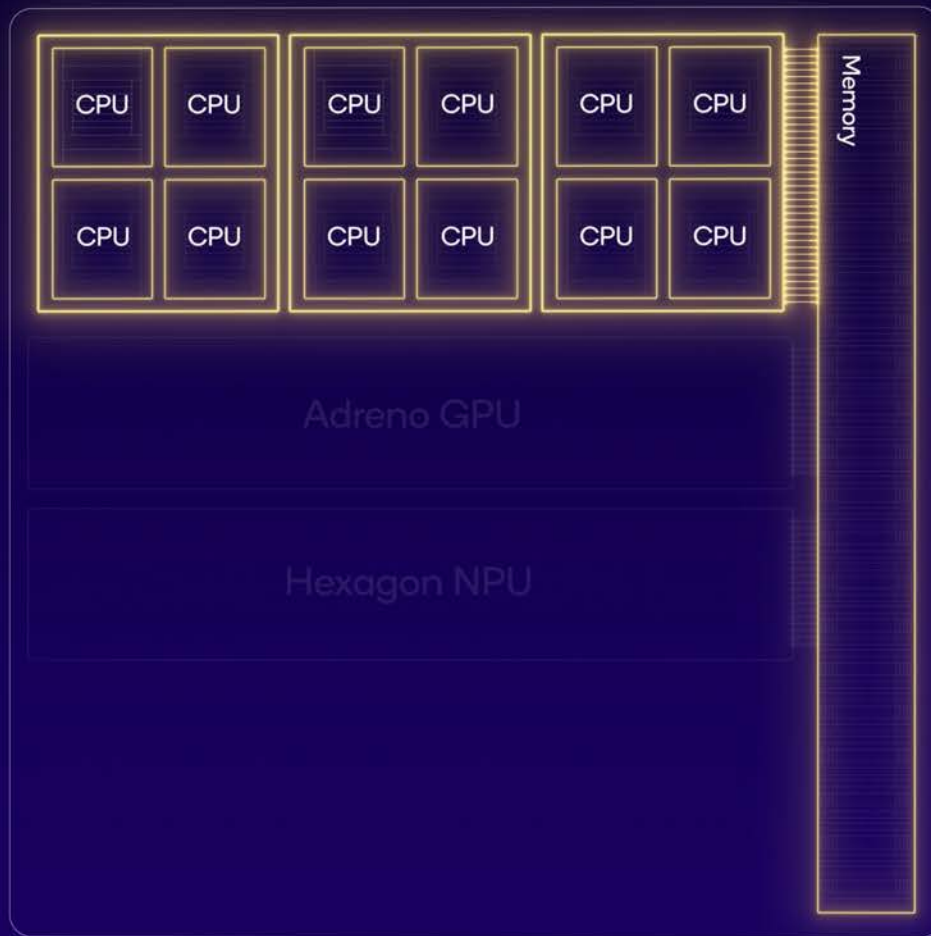
LPDDR5x

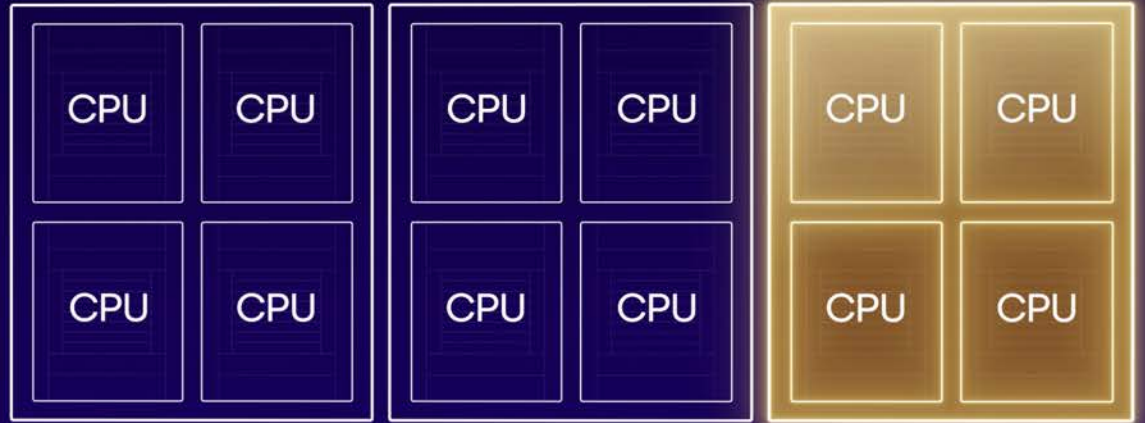
136 GB/s

memory bandwidth

42MB

total cache



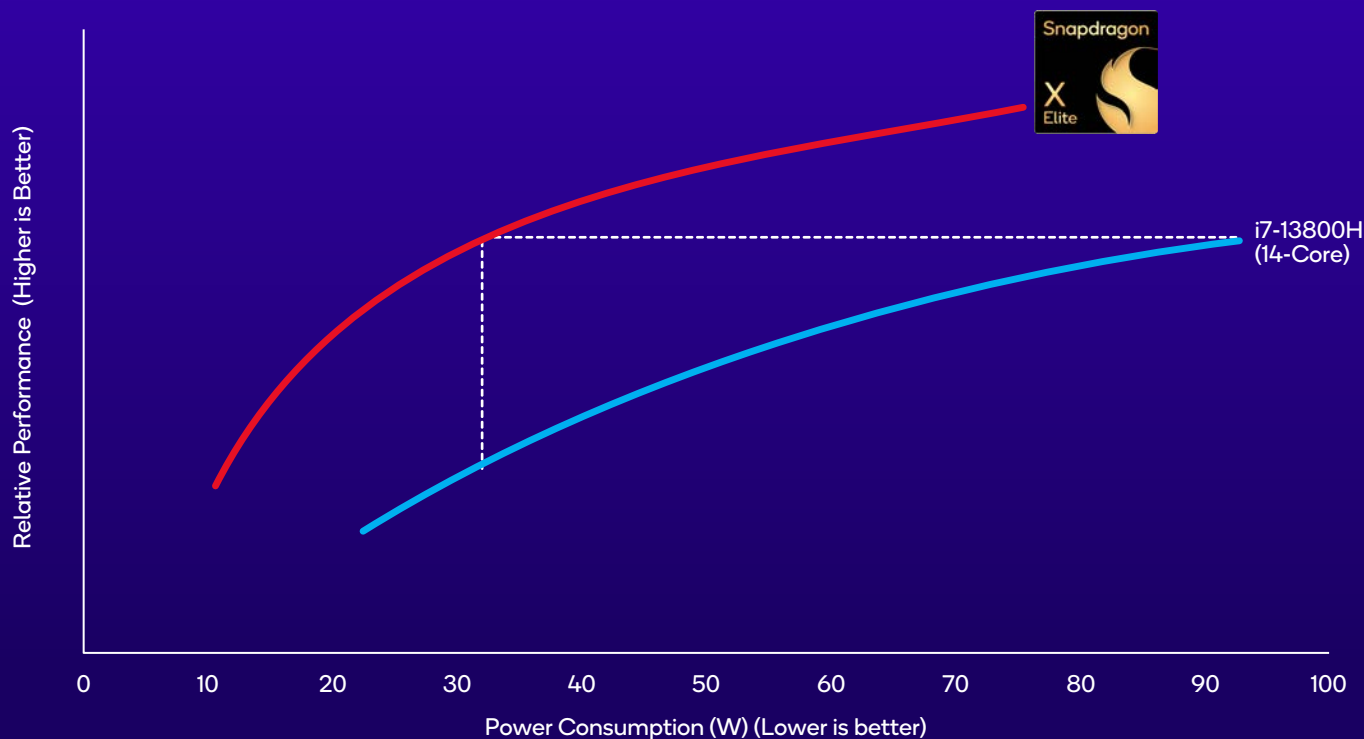


**Scalable across a broad range of thermal designs.
Delivering leading performance and power.**



Best-in-Class CPU

Multi-threaded Performance



i7-13800H
(14-Core)

Up to
2X
Faster CPU
performance vs.
competition at
ISO power

Matches competitor
peak performance at
65%
Less power

CPU Performance is based on Cinebench 2024 Multi-Thread on Windows OS run in October 2023. Snapdragon X Elite was tested using a Qualcomm laptop reference design on Windows OS and no thermal throttling impact due to length of test. The i7-13800H (14 core) was tested using a Razer Blade 15 2023 (RZ09-0485) laptop. Maximum performance reflected by i7-13800H represents maximum achievable results in given platforms under unconstrained PL1/PL2 settings, and Razer Synapse CPU settings to "Boost" and fan control locked to highest speed, thermal throttling was observed above stated maximum measured performance-power point. Power and performance comparison reflects results based on measurements and hardware instrumentation of given devices.



Best-in-class CPU

Multi-threaded Performance

Up to

2X

Faster peak performance vs. M2

CPU Performance is based on Cinebench 2024 Multi-Thread run in October 2023. Snapdragon X Elite was tested using a Qualcomm laptop reference design running on a 'September 2023 pre-production' build of Windows OS. The M2 was tested using a MacBook Pro 13" 2022 (A2338-8162) 8/10C + 16GB laptop running Mac OS. Performance comparison reflects results based on measurements and hardware instrumentation of given devices.



Premium
integrated GPU

4.6
TFLOPS



Displays for days



Support for internal display up to UHD HDR10 at 120 Hz

Triple UHD HDR10 60 Hz or dual 5K 60Hz display support

Upgradeable drivers



DAVE LEBOLT

Head of Strategy, DaVinci Systems
Black Magic Design



Qualcomm

Blackmagicdesign



Qualcomm

ÁINE SHIVNAN

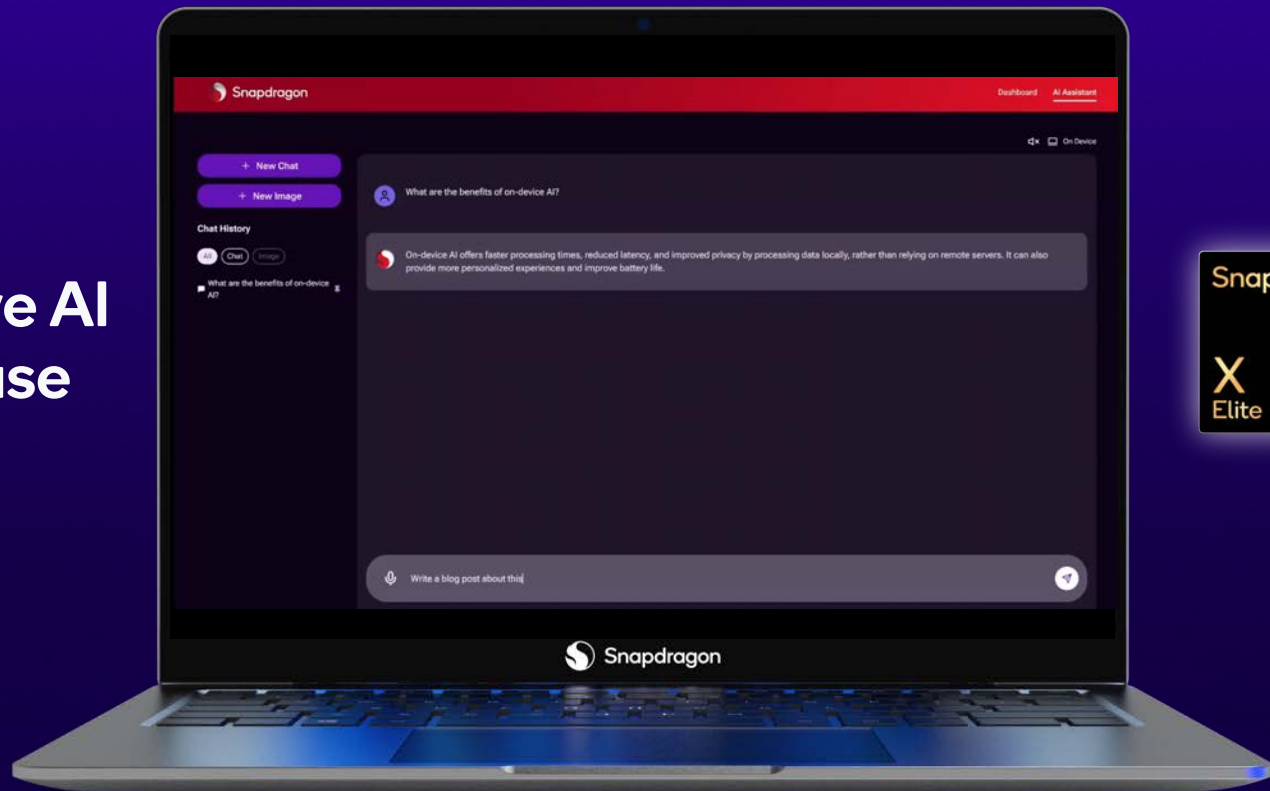
VP, Engineering

Qualcomm Technologies, Inc.



On-device AI

Generative AI powerhouse



Stable Diffusion (in seconds)

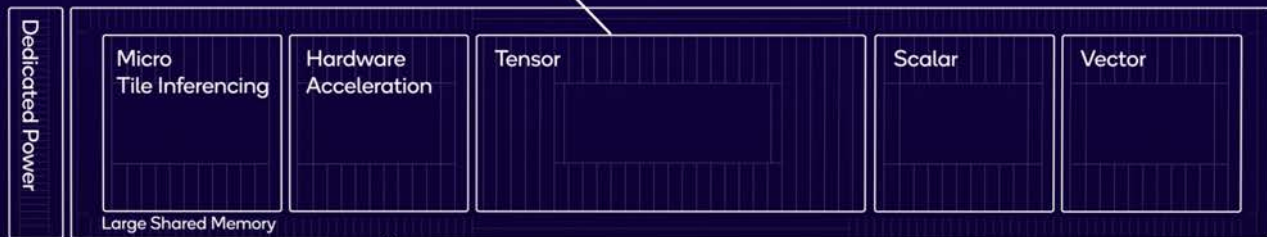
(Lower is better)



45 TOPS
INT4 support

2.5X

Faster Tensor accelerator



2X

Large Shared Memory

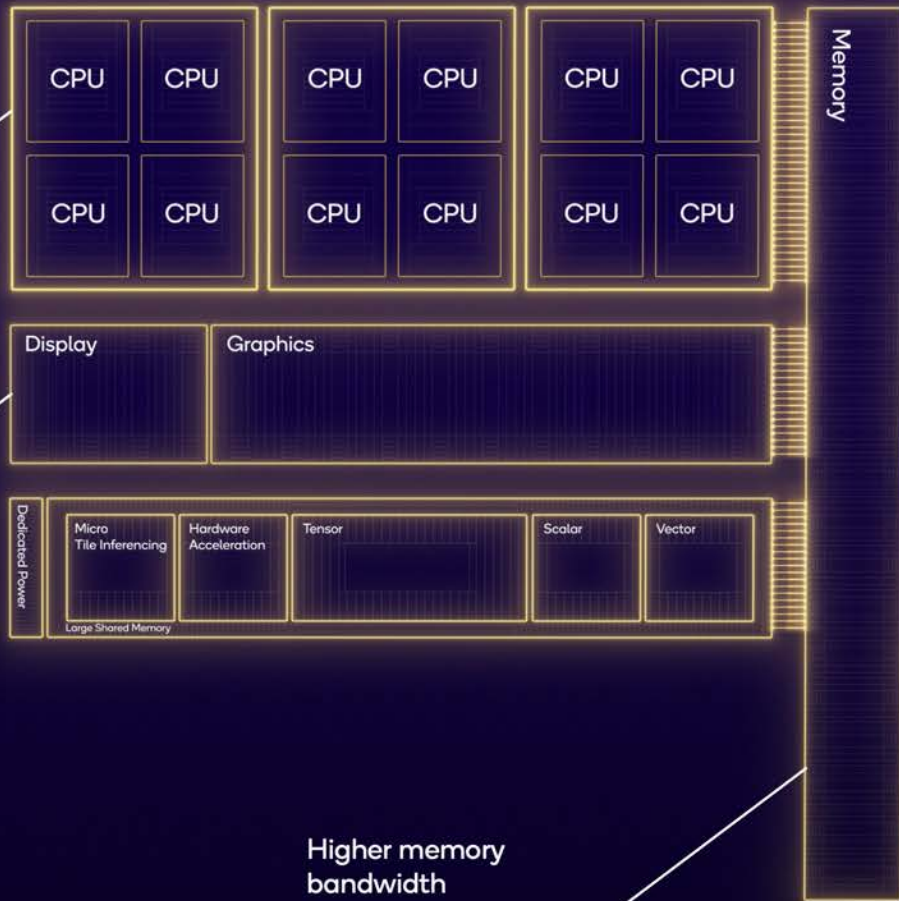
5X

AI faster compute
performance

50%

Higher GPU AI
compute performance

Qualcomm® AI Engine





Up to
10X
FASTER
PERFORMANCE

UL Procyon AI

Snapdragon X Elite



Core i7-13800H



Ryzen-9 7940HS



NPU Performance is based on UL Procyon AI 2.6.879 on Windows OS run in October 2023. Snapdragon X Elite was tested using a Qualcomm laptop reference design on a pre-production build of Procyon AI and a 'September 2023 pre-production' build of Windows OS, running the NPU integer variant of the test on the SNPE backend. The i7-13800H (14 core) was tested using a Razer Blade 15 2023 (RZ09-0485) laptop on Windows 11 running the CPU integer variant on the OpenVINO backend. Maximum performance reflected by i7-13800H represents maximum achievable results in given platform under unconstrained PL1/PL2 settings and no thermal limitations. The Ryzen 9-7940HS (8 core) was tested using an Asus ROG Zephyrus G14 2023 (GA402XV) laptop on Windows 11 running the CPU integer variant on the Windows ML backend. Maximum performance reflected by Ryzen 9-7940HS represents maximum achievable results in given platform under 80W SlowLimit/FastLimit settings and no thermal limitations.

Qualcomm[®] Sensing Hub



Sensors



Voice/Audio



Connectivity



Always-sensing ISP

2X

More powerful in
AI performance

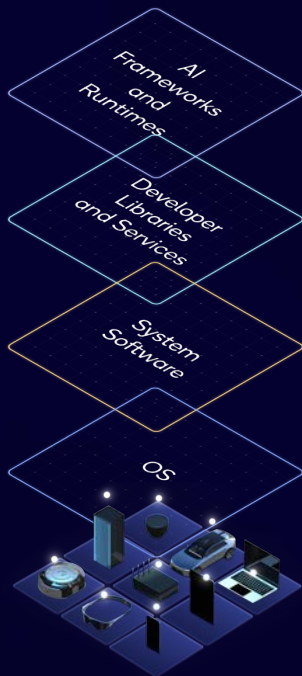
50% More memory





Qualcomm AI Stack

Qualcomm® AI Studio



AI frameworks



TensorFlow



PyTorch



ONNX



Keras

AI runtimes

Qualcomm® Neural Processing SDK



ONNX
RUNTIME

Direct ML

Qualcomm® AI Engine direct

Compilers

Core Libraries

Profilers and Debuggers

Programming Languages

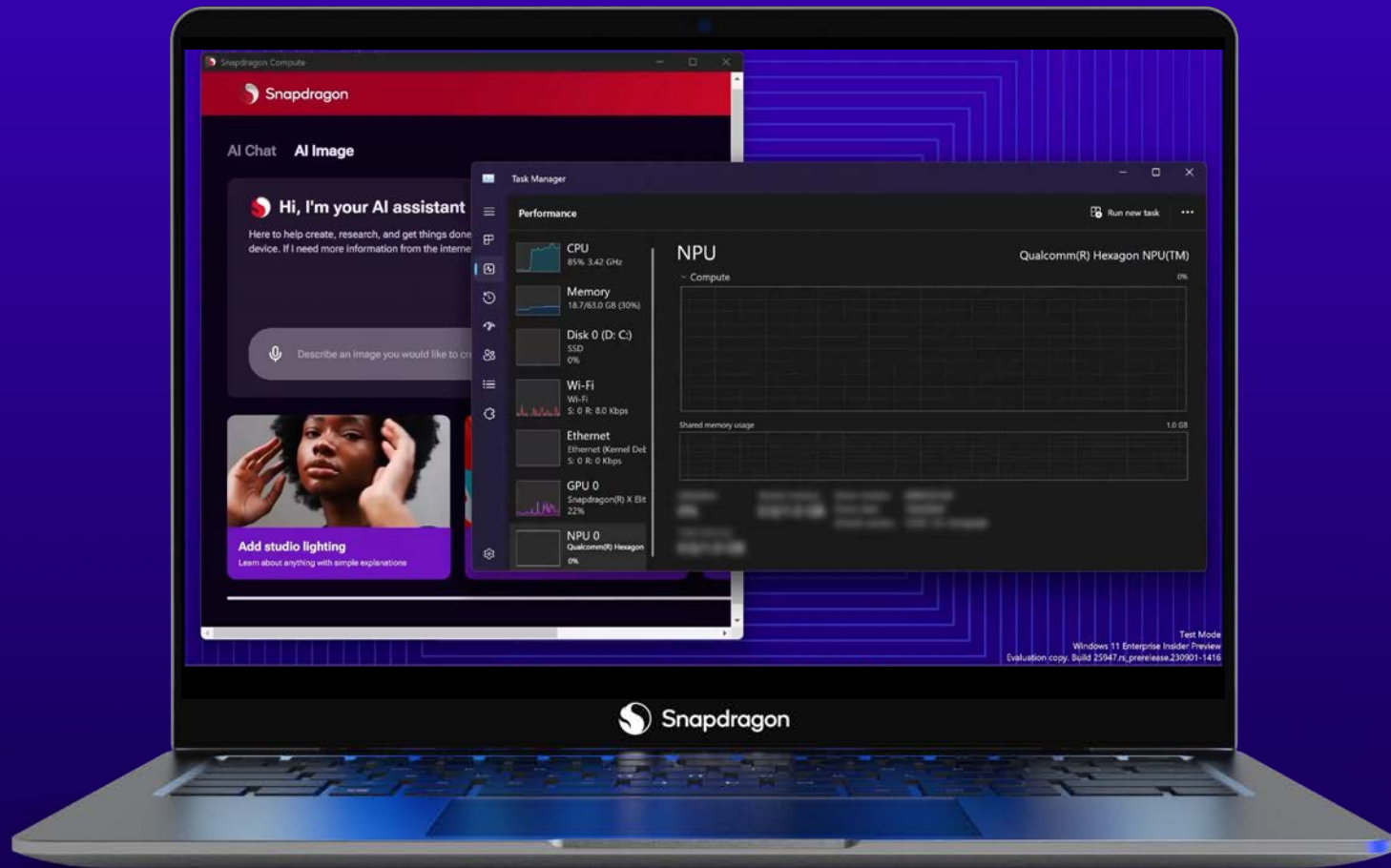
System Interface

SoC Driver

MCDM driver



Windows 11



Test Mode
Windows 11 Enterprise Insider Preview
Evaluation copy. Build 25H47.rs.prerelease.230901-1416

Built for AI



Qualcomm

BOBBY MOORE

Sr. Director for PS Portfolio Component Strategy

HP



Qualcomm



Qualcomm

SASCHA SEGAN

Sr. Manager, Public Relations
Qualcomm Technologies, Inc.



Snapdragon
connect

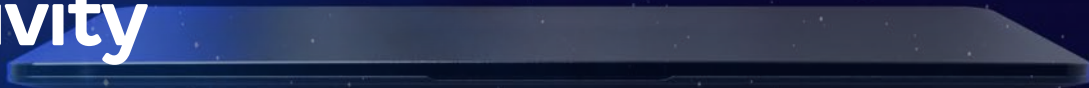


Multi-link



10GBs speed

Lightning-fast connectivity





Snapdragon
sight

Advanced camera

High-quality imaging

AI-accelerated video

MIPI camera support





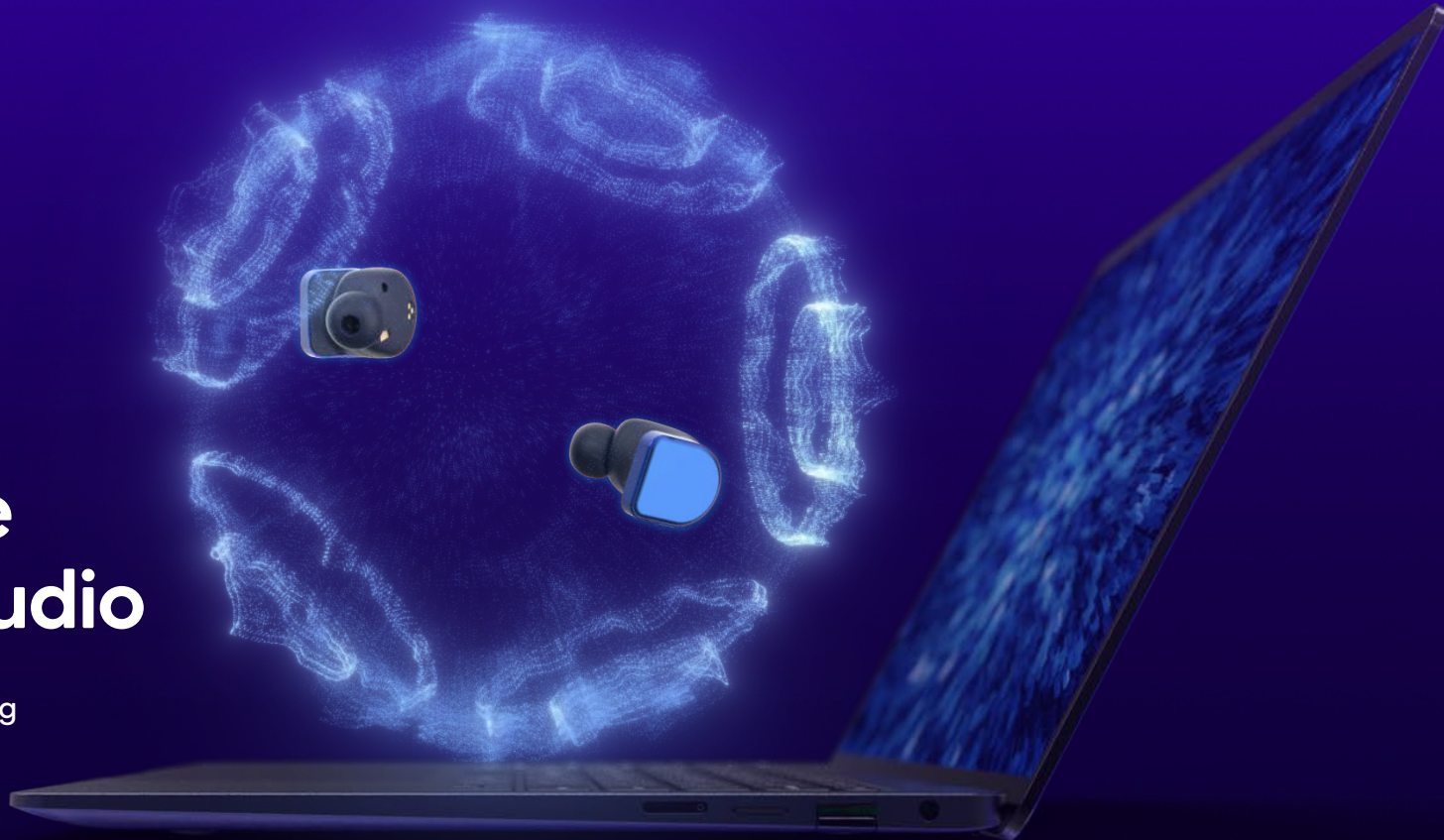
Snapdragon
sound

Immersive lossless audio

High-fidelity music listening

Lag-free entertainment

Crystal-clear video calls



Smart user experiences



Lightning-fast connectivity

The image shows a laptop screen with a blue, flowing, ribbon-like background. Four circular icons are overlaid on the screen: a Wi-Fi symbol with the number 7, a 5G symbol, a Multi-link symbol (two interlocking arrows), and a 10GBs speed symbol (a speedometer). Below the screen, the Snapdragon connect logo is visible, consisting of a red and white stylized 'S' with a circular arrow around it.



Advanced camera

The image shows a woman's profile in a dark setting. A grid of light points is overlaid on her face, representing facial recognition or advanced camera technology. Below her, the Snapdragon sight logo is visible, consisting of a red and white stylized 'S' with a camera lens icon.



Immersive lossless audio

The image shows a laptop screen with a blue, flowing, ribbon-like background. A glowing, blue, wireframe sphere is overlaid on the screen, representing immersive audio. Two small camera icons are visible on the sphere. Below the screen, the Snapdragon sound logo is visible, consisting of a red and white stylized 'S' with a circular arrow around it.

Qualcomm

NITIN KUMAR

Sr. Director, Product Management

Qualcomm Technologies, Inc.



Snapdragon

X
Elite



500+ enterprises

Testing or deploying PCs
powered by Snapdragon



Chip-to-cloud security



Snapdragon
secure



Microsoft secured-core
PC support

Qualcomm®
Trusted Execution
Environment

Layered secure boot

Zero Trust
protection

Device
resilience

Total memory
encryption

Hardware
cryptography

Qualcomm® Secure
Processing Unit with
Microsoft Pluton solution

AI transforming the enterprise

94%

of business leaders indicate AI has already improved their productivity at work.*

~50%

of IT decision makers are ready to switch PC brands based on AI performance.**

*Deloitte – State of AI (2022).

**IDC's 2023 U.S. Commercial PC Survey — AI PC Results, Doc. # US51194123, September 2023







BALAJI RAGHAVAN

Chief Technology Officer
Uniphore



Uniphore Overview

Largest Global AI-Native Enterprise-Scale Company

GROWTH

- Founded in 2008
- HQ: Palo Alto, CA
- Global Presence
- ~850 employees
- Hypergrowth YoY

\$100M+
cARR

1,500+

Customers &
End Clients

750k

User Base

INVESTORS

\$620M

Total Raised

February 2022
Series E \$400M

\$2.5B
Valuation

NEA

سنانيل للاستثمار
SANABIL INVESTMENTS



MUBADALA

JO2 VENTURES

MARCH
CAPITAL

PLATFORM

Multimodal AI and data platform with pre-defined industry templates to accelerate time-to-value for enterprises

Data
Capture &
Streaming

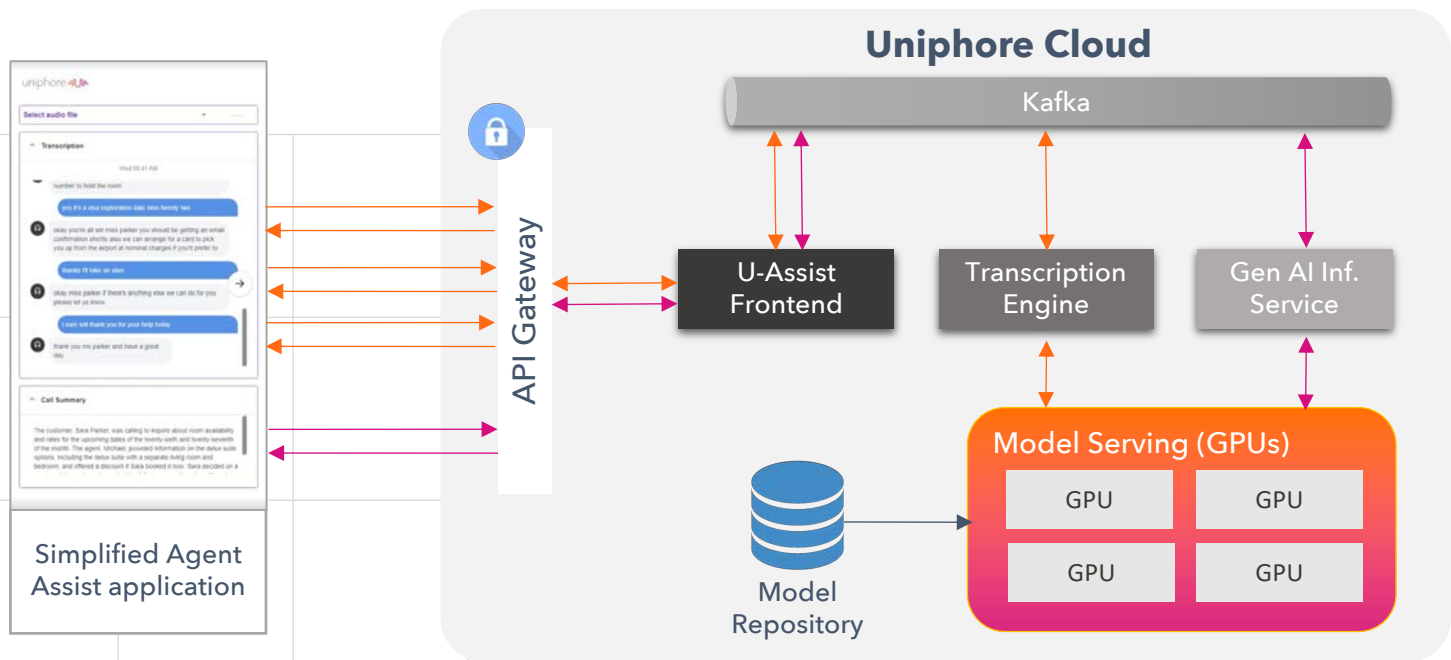
Generative
AI

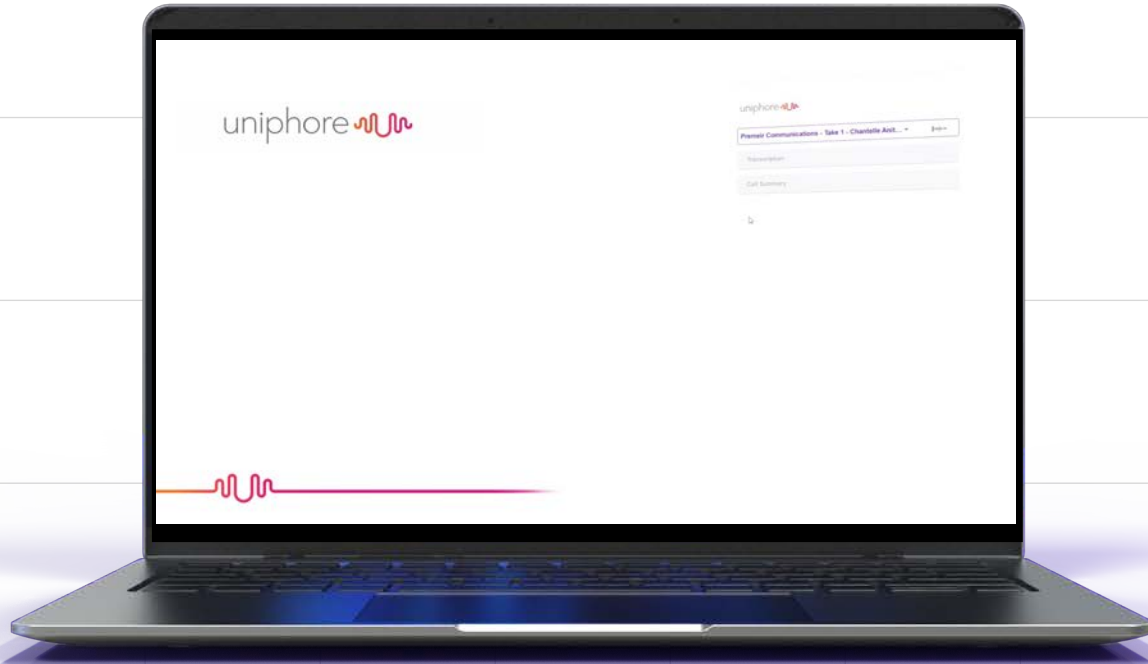
Knowledge
AI

Emotion
AI

Workflow
Automation

Uniphore AI | Snapdragon





Qualcomm

uniphore



Snapdragon Compute ecosystem

ODM

COMPAL



wlstron

英業達
Inventec

CONNECTIVITY

Fibocom

QUECTEL



IBV/UEFI



Docking



CAMERA



USB



EMBEDDED CONTROLLER



nuvoTon

Panel





Growing ISV momentum



Up to
25% faster
performance



Compile time
(Lower is better)

Snapdragon X Elite

25.72

i7-1360P (12-Core)

34.13

Partnering with leading PC OEMs

acer

ASUS®

DELL
Technologies



HONOR

Lenovo



Microsoft Surface

SAMSUNG







Best-in-class performance vs. x86

Up to	Up to
2X	2X
faster CPU	faster GPU
Qualcomm Oryon™ CPU 12 high-performance cores Dual-Core Boost	Qualcomm® Adreno™ GPU 4.6 teraflops Triple UHD monitor support

4nm process node

136GB/s

memory bandwidth

LPDDR5x

Generative AI powerhouse

Capable to run

13B+

parameters on device

Generates

30

tokens/sec for 7B LLMs

Built for AI

75 TOPS	<1 second
Qualcomm® AI Engine	Stable diffusion
45 TOPS	4.5X
Qualcomm® Hexagon™ NPU	faster AI NPU processing power than competitors

1st PC processor with integrated Always-Sensing ISP

Integrated Micro NPU on Qualcomm Sensing Hub

Smart user experiences

- Lightning-fast 5G | Wi-Fi 7
- Immersive lossless audio
- Advanced camera ISP
- Snapdragon Seamless
- Chip-to-cloud security

Leading PC performance per watt

Matches peak PC performance at

68%

less power vs. competition

Scalable across a range of thermal designs and form factors

Qualcomm, Snapdragon, Qualcomm Oryon, Adreno, Hexagon, Snapdragon Sight, Snapdragon Sound, Snapdragon Smart and Snapdragon Seamless are trademarks or registered trademarks of Qualcomm Incorporated. | CPU Performance is based on Geekbench v6.2 Multi-Thread on Windows OS run in October 2023. Snapdragon X Elite was tested using a Qualcomm laptop reference design on Windows OS. The i7-1360P (12 core) and i7-1355U (10 core) were tested using a Samsung Galaxy Book3 360 13" 2023 (NP730QFG) laptop and Samsung Galaxy Book3 15.6" 2023 (NP750XFG) laptop, respectively on Windows 11. Maximum performance reflected by i7-1360P and i7-1355U represent maximum achievable results in given platforms under unconstrained PL1/PL2 settings and no thermal limitations. Power and performance comparison reflects results based on measurements and hardware instrumentation of given devices. GPU Performance is based on 3DMark WildLife Extreme run in October 2023. Snapdragon X Elite was tested using a Qualcomm laptop reference design on Windows OS and a pre-commercial build of Wildlife Extreme. The i7-13800H (14 core) was tested using a Razer Blade 15 2023 (R2079-0465) laptop on Windows 11. Maximum performance reflected by i7-13800H represents maximum achievable results in given platform under unconstrained PL1/PL2 settings and no thermal limitations. Power and performance comparison reflects results based on measurements and hardware instrumentation of given devices.

THANK YOU



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For more information, visit us at:

snapdragon.com & snapdragoninsiders.com

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